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MAR 21 2002
PATENT & TRADEMARK OFFICE

Honeywell Docket No. H0001719 (4960)
Practitioner Docket No. 100665.0042US1

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231

Inventor: **Johnson, et al.**
Serial No: **09/933,596**
Filed: **August 20, 2001**
For: **Configurations and Methods
for Improved Copper
Distribution Uniformity in
Printed Wiring Boards**

Examiner: Tuan T. Dinh
Art Unit: 2827

4/11/02
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RESPONSE TO OFFICE ACTION

The Honorable Commissioner
of Patents and Trademarks
Washington, D.C. 20231

Dear Sir:

This paper responds to the Office Action dated February 20, 2002. Please enter the following:

Restriction Requirement

The Applicant elects Group I, claims 1-10, without traverse.

In the Claims

Please cancel claims 11-20.

US 0993359609P1



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Remarks:

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